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BAV23QA

Dual common cathode high-voltage switching diode

9 April 2018

Product data sheet

1. General description

Dual common cathode high-voltage switching diode, encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} \leq 50$ ns
- Low leakage current: $I_R \leq 100$ nA
- High reverse voltage: $V_R \leq 200$ V
- Low capacitance: $C_d \leq 2$ pF
- Ultra small and leadless SMD plastic package
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

3. Applications

- High-speed switching
- General-purpose switching
- Voltage clamping
- Reverse polarity protection

4. Quick reference data

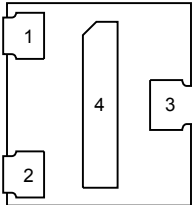
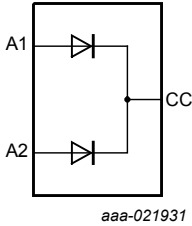
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current	single diode loaded; $T_j = 25$ °C	[1]	-	-	330	mA
V_R	reverse voltage	$T_j = 25$ °C		-	-	200	V
V_{RRM}	repetitive peak reverse voltage			-	-	250	V
V_F	forward voltage	$I_F = 200$ mA; $t_p \leq 300$ μ s; $\delta \leq 0.02$; $T_j = 25$ °C		-	-	1.25	V
I_R	reverse current	$V_R = 200$ V; pulsed; $T_j = 25$ °C		-	-	100	nA
t_{rr}	reverse recovery time	$I_F = 30$ mA; $I_R = 30$ mA; $R_L = 100$ Ω ; $I_{R(meas)} = 3$ mA; $T_j = 25$ °C		-	-	50	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)	 <p>Transparent top view DFN1010D-3 (SOT1215)</p>	
2	A2	anode (diode 2)		
3	CC	common cathode		
4	CC	common cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAV23QA	DFN1010D-3	plastic, thermal enhanced ultra thin small outline package; 3 terminals; 0.75 mm pitch; 1.1 mm x 1 mm x 0.37 mm body	SOT1215

7. Marking

Table 4. Marking codes

Type number	Marking code
BAV23QA	X 010

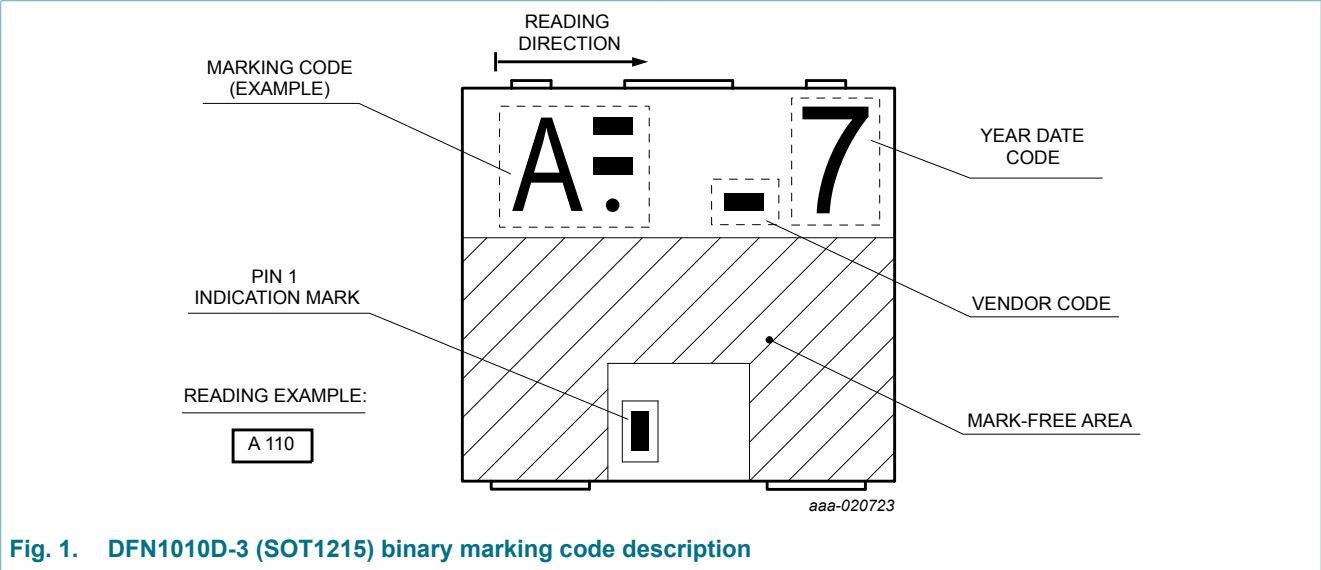


Fig. 1. DFN1010D-3 (SOT1215) binary marking code description

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134)

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_{RRM}	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	250	V
V_R	reverse voltage			-	200	V
I_F	forward current	single diode loaded; $T_j = 25\text{ °C}$	[1]	-	330	mA
		double diode loaded; $T_j = 25\text{ °C}$	[1]	-	190	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 1\text{ }\mu\text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	9	A
		$t_p = 100\text{ }\mu\text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	3	A
		$t_p = 10\text{ ms}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	1.7	A
I_{FRM}	repetitive peak forward current	$t_p \leq 1\text{ ms}$; $\delta \leq 0.25$		-	900	mA
Per device, one diode loaded						
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25\text{ °C}$	[1]	-	350	mW
			[2]	-	610	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{\text{th}(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	355	K/W
			[2]	-	-	205	K/W
$R_{\text{th}(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	45	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

[3] Soldering point of cathode tab.

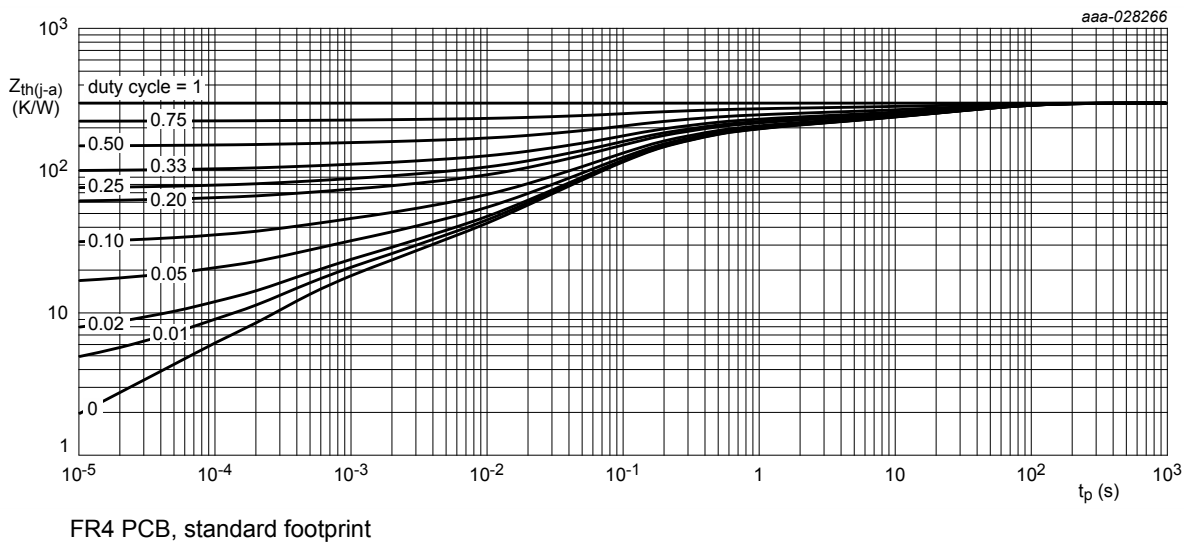


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

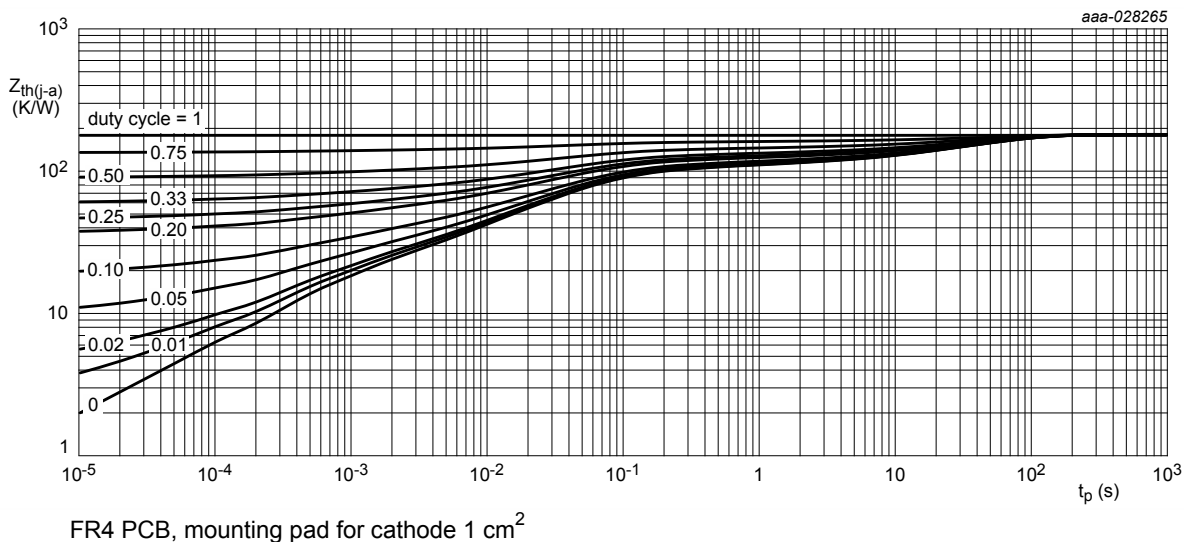
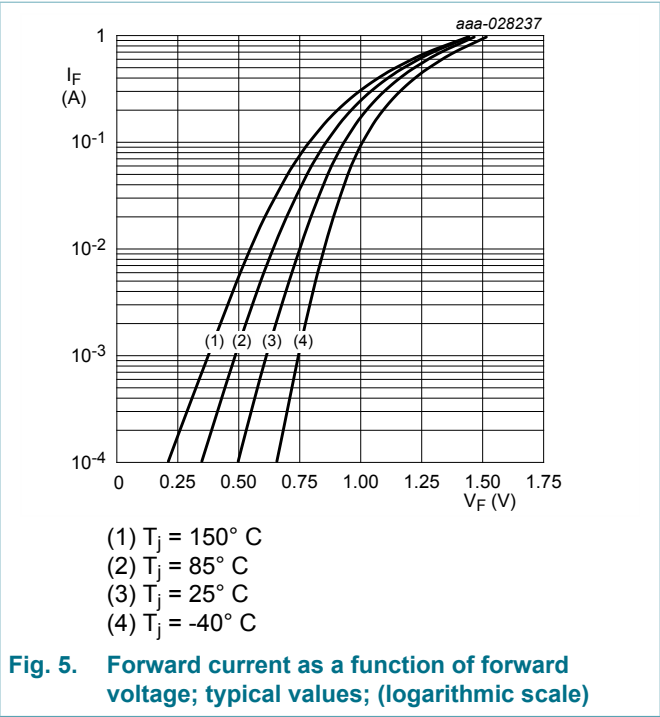
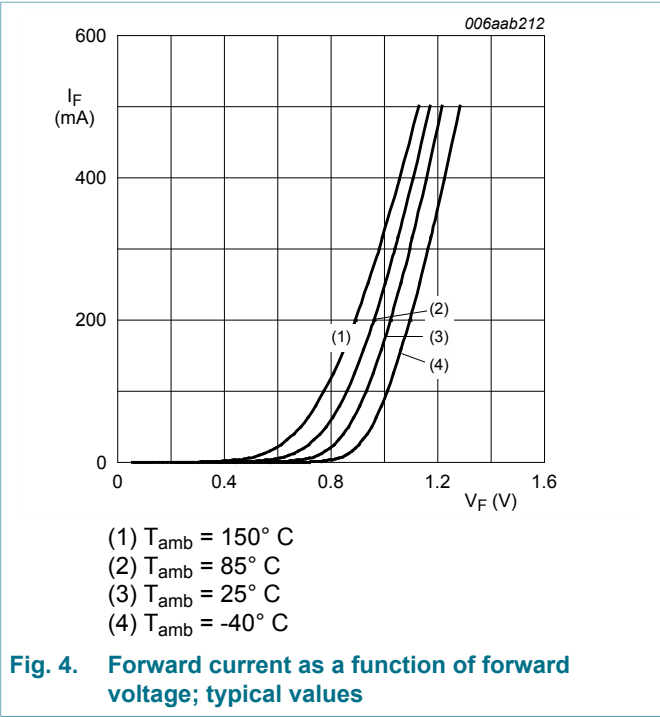


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per diode						
V_F	forward voltage	$I_F = 100\text{ mA}$; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$; $T_j = 25\text{ }^\circ\text{C}$	-	-	1	V
		$I_F = 200\text{ mA}$; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$; $T_j = 25\text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 200\text{ V}$; pulsed; $T_j = 25\text{ }^\circ\text{C}$	-	-	100	nA
		$V_R = 200\text{ V}$; pulsed; $T_j = 150\text{ }^\circ\text{C}$	-	-	100	μA
C_d	diode capacitance	$V_R = 0\text{ V}$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$	-	-	2	pF
t_{rr}	reverse recovery time	$I_F = 30\text{ mA}$; $I_R = 30\text{ mA}$; $R_L = 100\text{ }\Omega$; $I_{R(\text{meas})} = 3\text{ mA}$; $T_j = 25\text{ }^\circ\text{C}$	-	-	50	ns



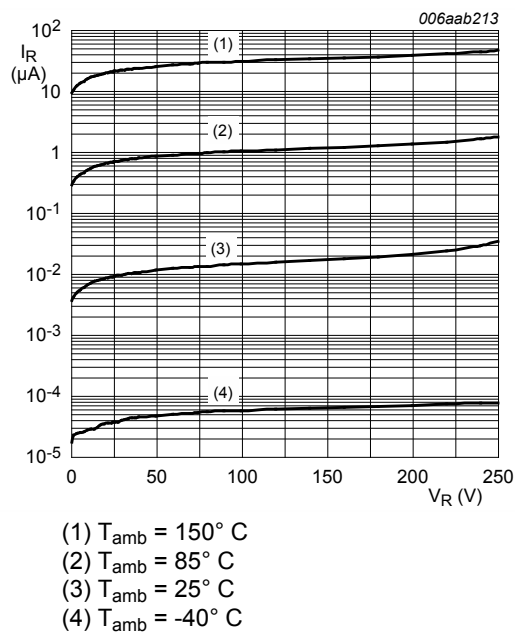


Fig. 6. Reverse current as a function of reverse voltage; typical values

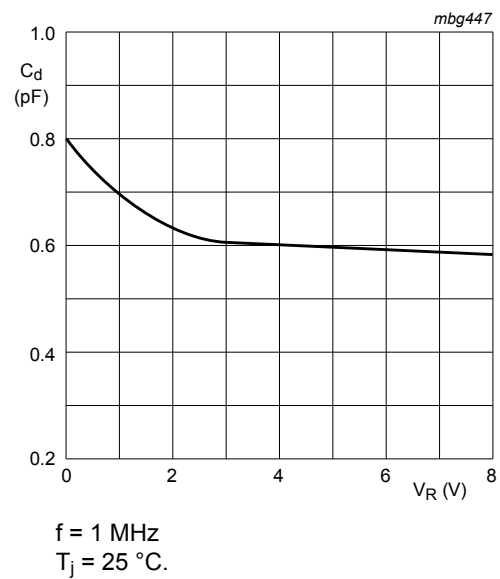
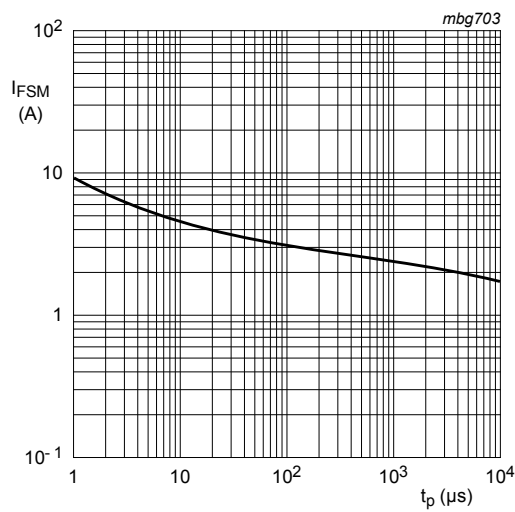


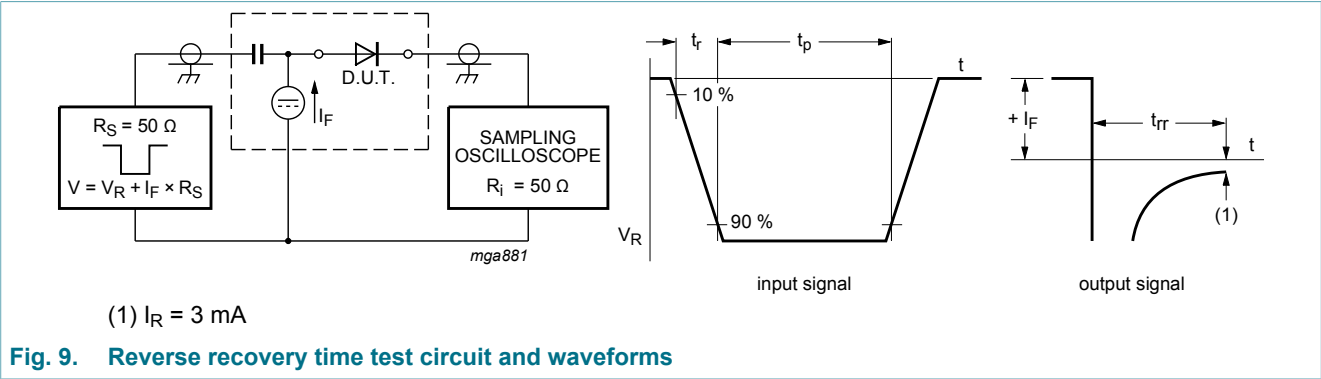
Fig. 7. Diode capacitance as a function of reverse voltage; typical values.



Based on square wave currents.
 $T_{j(\text{init})} = 25^\circ\text{C}$

Fig. 8. Non-repetitive peak forward current as a function of pulse duration; maximum values

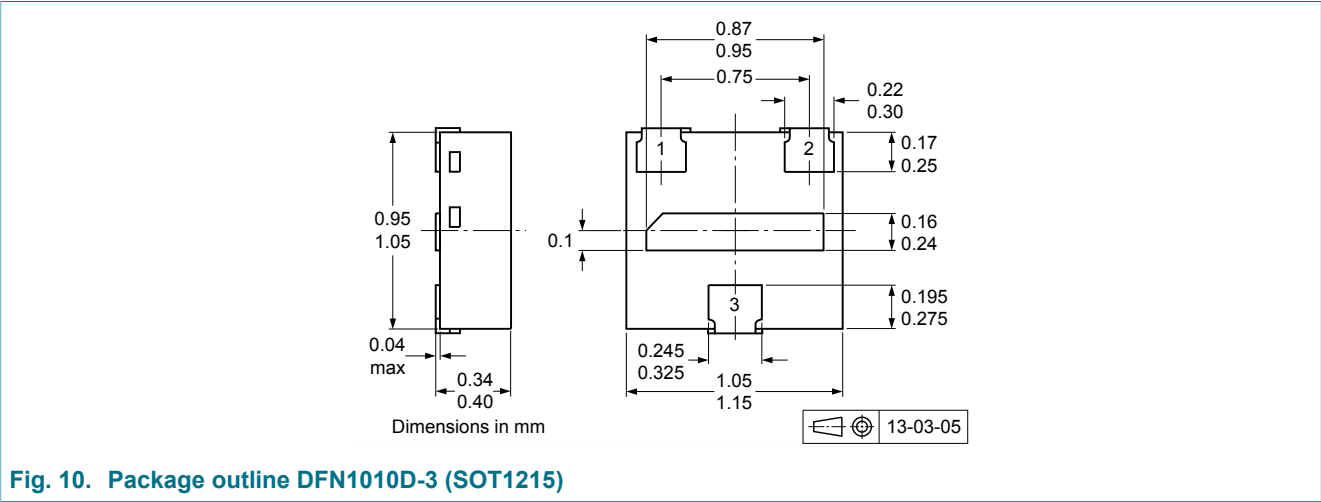
11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

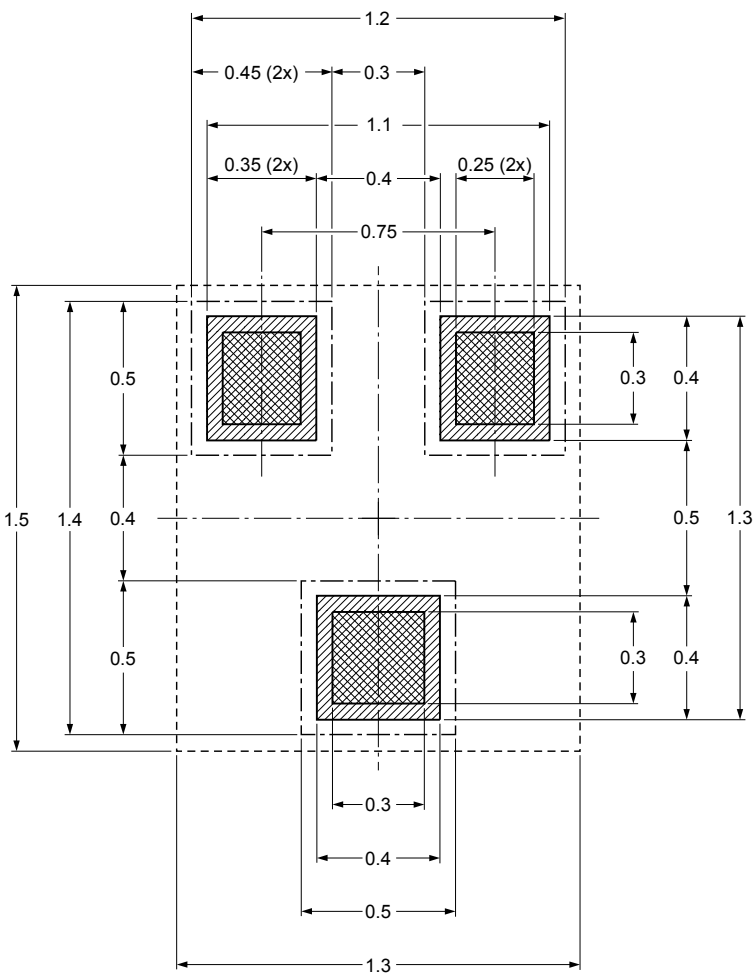
12. Package outline



13. Soldering

Footprint information for reflow soldering of DFN1010D-3 package

SOT1215



- solder land
- solder land plus solder paste
- occupied area
- solder resist

Dimensions in mm

Issue date ~~12-11-23~~
13-03-06

sot1215_fr

Fig. 11. Reflow soldering footprint for DFN1010D-3 (SOT1215)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAV23QA v.1	20180409	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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